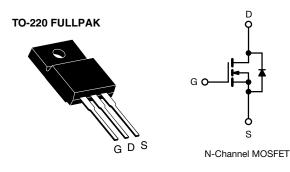
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	700)
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.6
Q _g max. (nC)	48	
Q _{gs} (nC)	6	
Q _{gd} (nC)	11	
Configuration	Sing	le

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION Package TO-220 FULLPAK Lead (Pb)-free and Halogen-free SiHF6N65E-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	650	V	
Gate-Source Voltage		V _{GS}	± 30	- V	
Continuous Drain Current (T _{.1} = 150 °C) ^e	V_{GS} at 10 V $\frac{T_C = 25 \degree C}{T_C = 100 \degree C}$	1-	7		
Continuous Drain Current $(1_j = 150^{\circ} C)^{\circ}$	$T_{\rm C} = 100 ^{\circ}{\rm C}$	I _D	5	Α	
lsed Drain Current ^a		I _{DM}	18		
Linear Derating Factor			0.63	W/°C	
Single Pulse Avalanche Energy ^b		E _{AS}	56	mJ	
Maximum Power Dissipation	PD	31	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C	-I) / / -I+	37	V/no	
Reverse Diode dV/dt ^d		dV/dt	27	V/ns	
Soldering Recommendations (Peak temperature) ^c	For 10 s		300	°C	
Mounting Torque	M3 screw		0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

e. Limited by maximum junction temperature.

S16-1602-Rev. C, 15-Aug-16

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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-		65			00 AM		
Maximum Junction-to-Case (Drain)	R _{thJC}	-		4.0			°C/W		
		•							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D =	250 µA	650	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.73	-	V/°C	
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D =	250 µA	2	-	4	V	
Osta Osuma Laskara		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA		
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 30$	V	-	-	± 1	V V/°C V	
Zero Gate Voltage Drain Current		V _{DS} =	= 650 V, V _C	_{as} = 0 V	-	-	1	V V/°C V nA μA Ω S PF nC nS	
	IDSS	$V_{DS} = 520 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA		
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$		I _D = 3 A	-	0.5	0.6	Ω	
Forward Transconductance	9 _{fs}	V _{DS}	= 30 V, I _D	= 3 A	-	2	-	S	
Dynamic		•			•				
Input Capacitance	C _{iss}		$V_{GS} = 0 V$	1	-	820	-		
Output Capacitance	C _{oss}		$V_{DS} = 100$	V,	-	40	-		
Reverse Transfer Capacitance	C _{rss}		f = 1 MH	Z	-	4	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		(to 500)/		-	36	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$v_{\rm DS} = 0.0$	/ to 520 V,	$v_{GS} = 0 v$	-	117	-		
Total Gate Charge	Qg				-	24	48		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 3 .	A, V _{DS} = 520 V	-	6	-	nC	
Gate-Drain Charge	Q _{gd}				-	11	-		
Turn-On Delay Time	t _{d(on)}				-	14	28		
Rise Time	t _r	$V_{DD} = 520 \text{ V}, \text{ I}_{D} = 3 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	12	24	- ns		
Turn-Off Delay Time	t _{d(off)}			-	30	60			
Fall Time	t _f			-	20	40			
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.4	-	Ω		
Drain-Source Body Diode Characteristi	cs								
Continuous Source-Drain Diode Current	۱ _S	MOSFET syml showing the	bol		-	-	7		
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	18	A	
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 3 A	, V _{GS} = 0 V	-	-	1.3	V	
Reverse Recovery Time					1	ł			
					-	237	-	ns	
Reverse Recovery Charge	t _{rr} Q _{rr}	$T_{\rm J} = 2$	25 °C, I _F = 100 Α/μs,	$I_{\rm S} = 3 \rm A,$	-	237 2.2	-	ns µC	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

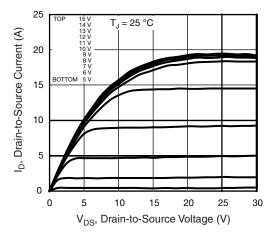


Fig. 1 - Typical Output Characteristics

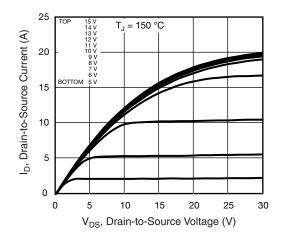


Fig. 2 - Typical Output Characteristics

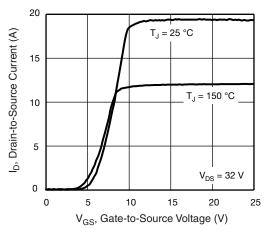


Fig. 3 - Typical Transfer Characteristics

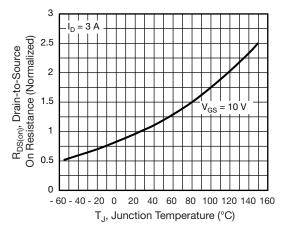


Fig. 4 - Normalized On-Resistance vs. Temperature

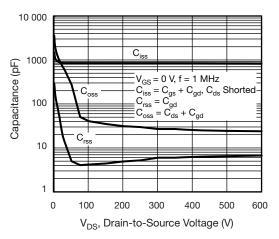


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

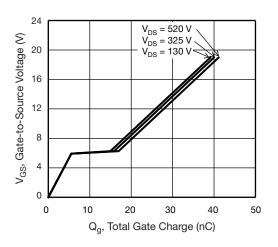


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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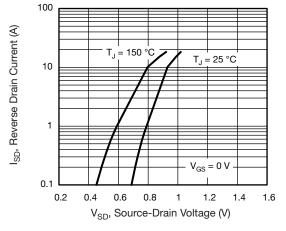


Fig. 7 - Typical Source-Drain Diode Forward Voltage

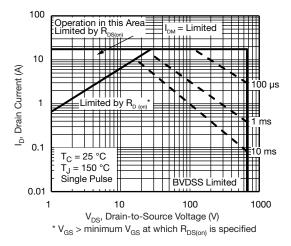


Fig. 8 - Maximum Safe Operating Area

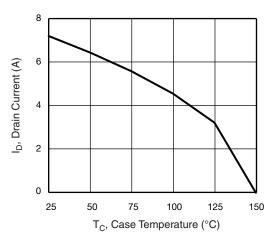


Fig. 9 - Maximum Drain Current vs. Case Temperature

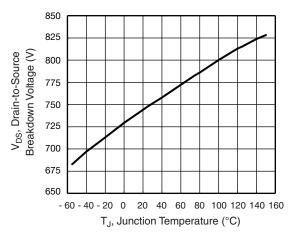
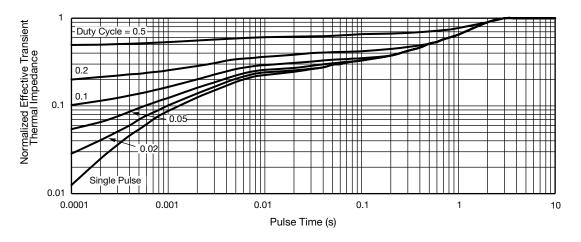


Fig. 10 - Temperature vs. Drain-to-Source Voltage





S16-1602-Rev. C, 15-Aug-16

4

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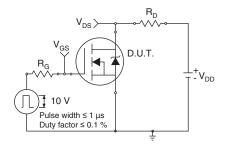


Fig. 12 - Switching Time Test Circuit

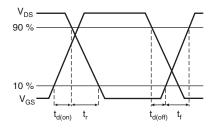


Fig. 13 - Switching Time Waveforms

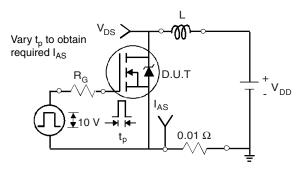


Fig. 14 - Unclamped Inductive Test Circuit

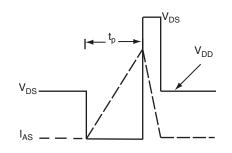


Fig. 15 - Unclamped Inductive Waveforms

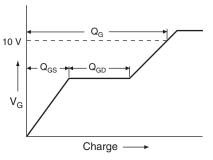


Fig. 16 - Basic Gate Charge Waveform

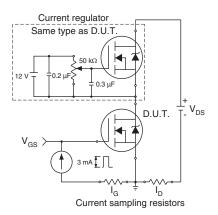


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit

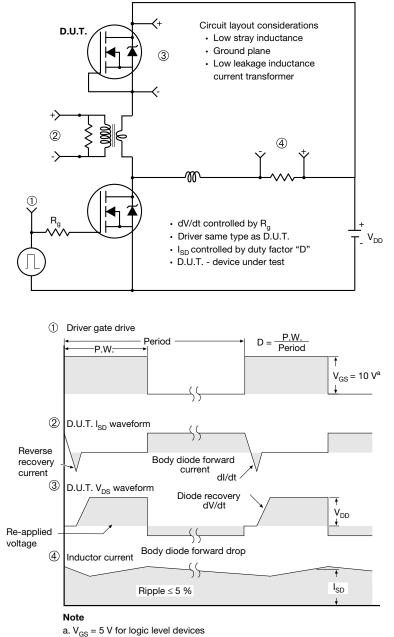


Fig. 18 - For N-Channel

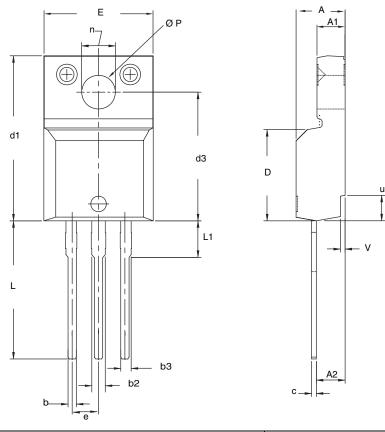
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Package Information

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TO-220 FULLPAK (HIGH VOLTAGE)



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54 BSC		0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØР	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$.

4. All dimensions include burrs and plating thickness.

5. No chipping or package damage.



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